



## SY54023R

Low Voltage 1.2V/1.8V CML 2x2 Crosspoint Switch with Fail-Safe Inputs, 3.2Gbps, 2.5GHz

### General Description

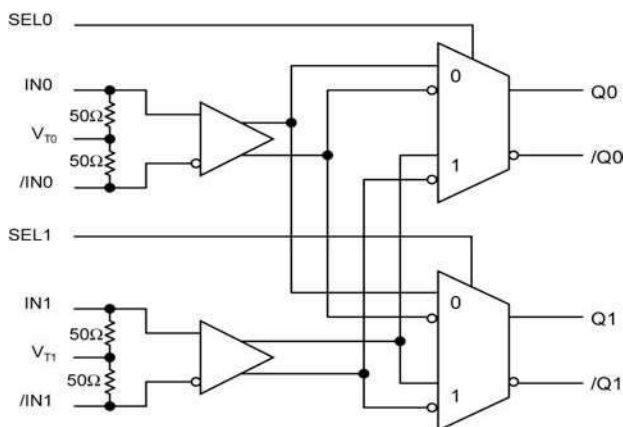
The SY54023R is a fully differential, low voltage 1.2V/1.8V CML 2x2 Crosspoint Switch with Fail Safe Inputs. The SY54023R can process clock signals as fast as 2.5GHz or data patterns up to 3.2Gbps.

The differential input includes Micrel's unique, 3-pin input termination architecture that interfaces to LVPECL, LVDS or CML differential signals, (AC- or DC-coupled from a 2.5V driver) as small as 100mV (200mV<sub>PP</sub>) without any level-shifting or termination resistor networks in the signal path. For AC-coupled input interface applications, an internal voltage reference is provided to bias the V<sub>T</sub> pin. The outputs are CML, with extremely fast rise/fall times guaranteed to be less than 95ps.

The SY54023R operates from a 2.5V ±5% core supply and a 1.8V or 1.2V ±5% output supply and is guaranteed over the full industrial temperature range (-40°C to +85°C). The SY54023R is part of Micrel's high-speed, Precision Edge<sup>®</sup> product line.

Datasheets and support documentation can be found on Micrel's web site at: [www.micrel.com](http://www.micrel.com).

### Functional Block Diagram



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Precision Edge<sup>®</sup>

### Features

- 1.2V/1.8V CML 2x2 Crosspoint Switch with Fail Safe Inputs
- Guaranteed AC performance over temperature and voltage:
  - DC-to- > 3.2Gbps throughput
  - <400ps propagation delay (IN-to-Q)
  - <15ps Output Skew
  - <95ps rise/fall times
- Ultra-low jitter design
  - <1p<sub>RMS</sub> cycle-to-cycle jitter
  - <10p<sub>SPP</sub> total jitter
  - <1p<sub>RMS</sub> random jitter
  - <10p<sub>SPP</sub> deterministic jitter
- High-speed CML outputs
- 2.5V ±5% , 1.8/1.2V ±5% power supply operation
- Industrial temperature range: -40°C to +85°C
- Available in 16-pin (3mm x 3mm) MLF<sup>®</sup> package

### Applications

- Data Distribution: OC-48, OC-48+FEC
- SONET clock and data distribution
- Fibre Channel clock and data distribution
- Gigabit Ethernet clock and data distribution

### Markets

- Storage
- ATE
- Test and measurement
- Enterprise networking equipment
- High-end servers
- Access
- Metro area network equipment

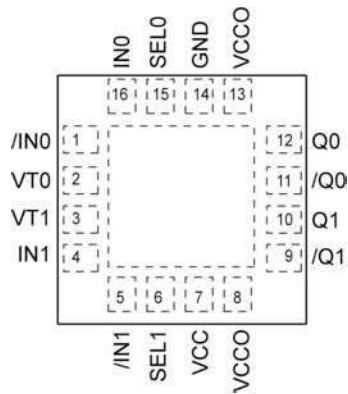
## Ordering Information<sup>(1)</sup>

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY54023RMG	MLF-16	Industrial	023R with Pb-Free bar-line indicator	NiPdAu Pb-Free
SY54023RMGTR <sup>(2)</sup>	MLF-16	Industrial	023R with Pb-Free bar-line indicator	NiPdAu Pb-Free

**Notes:**

1. Contact factory for die availability. Dice are guaranteed at  $T_A = 25^\circ\text{C}$ , DC Electricals only.
2. Tape and Reel.

## Pin Configuration



**16-Pin MLF<sup>®</sup> (MLF-16)**

## Pin Description

Pin Number	Pin Name	Pin Function
16,1 4,5	IN0, /IN0 IN1, /IN1	Differential Inputs: These input pairs are the differential signal inputs to the device. They accept differential signals as small as 100mV (200mV <sub>PP</sub> ). Each input pin internally terminates with 50Ω to the VT pin. If the input swing falls below a certain threshold (typical 30mV), the Fail-Safe Input (FSI) feature will guarantee a stable output by latching the output to its last valid state.
2 3	VT0 VT1	Input Termination Center-Tap: Each side of the differential input pair terminates to VT pin. This pin provides a center-tap to a termination network for maximum interface flexibility. An internal high impedance resistor divider biases VT to allow input AC-coupling. For AC-coupling, bypass VT with a 0.1μF low ESR capacitor to VCC. See "Interface Applications" subsection and Figure 2a.
15 6	SEL0 SEL1	These single-ended TTL/CMOS-compatible inputs select the inputs of the crosspoint switch. Note that these inputs are internally connected to a 25kΩ pull-up resistor and will default to a logic HIGH state if left open.
7	VCC	Positive Power Supply: Bypass with 0.1μF//0.01μF low ESR capacitors as close to the VCC pin as possible. Supplies input and core circuitry.
8,13	VCCO	Output Supply: Bypass with 0.1μF//0.01μF low ESR capacitors as close to the VCCO pins as possible. Supplies the output buffers.
14	GND, Exposed pad	Ground: Exposed pad must be connected to a ground plane that is the same potential as the ground pin.
12,11 10,9	Q0, /Q0 Q1, /Q1	CML Differential Output Pairs: Differential buffered copies of the input signal. The output swing is typically 390mV. See "Interface Applications" subsection for termination information.

## Truth Table

SEL0	SEL1	Q0	Q1
L	L	IN0	IN0
L	H	IN0	IN1
H	L	IN1	IN0
H	H	IN1	IN1

### Absolute Maximum Ratings<sup>(1)</sup>

Supply Voltage ( $V_{CC}$ )	.....	-0.5V to +3.0V
Supply Voltage ( $V_{CCO}$ )	.....	-0.5V to +2.7V
$V_{CC} - V_{CCO}$	.....	<1.8V
$V_{CCO} - V_{CC}$	.....	<0.5V
Input Voltage ( $V_{IN}$ )	.....	-0.5V to $V_{CC}$
CML Output Voltage ( $V_{OUT}$ )	.....	0.6V to $V_{CCO}+0.5V$
Current ( $V_T$ )		
Source or sink current on $V_T$ pin	.....	$\pm 100mA$
Input Current		
Source or sink current on ( $IN$ , $/IN$ )	.....	$\pm 50mA$
Maximum operating Junction Temperature	.....	125°C
Lead Temperature (soldering, 20sec.)	.....	260°C
Storage Temperature ( $T_s$ )	.....	-65°C to +150°C

### Operating Ratings<sup>(2)</sup>

Supply Voltage ( $V_{CC}$ )	.....	2.375V to 2.625V
$(V_{CCO})$	.....	1.14V to 1.9V
Ambient Temperature ( $T_A$ )	.....	-40°C to +85°C
Package Thermal Resistance <sup>(3)</sup>		
MLF <sup>®</sup>		
Still-air ( $\theta_{JA}$ )	.....	75°C/W
Junction-to-board ( $\psi_{JB}$ )	.....	33°C/W

### DC Electrical Characteristics<sup>(4)</sup>

$T_A = -40^\circ C$  to  $+85^\circ C$ , unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
$V_{CC}$	Power Supply Voltage Range	$V_{CC}$	2.375	2.5	2.625	V
		$V_{CCO}$	1.14	1.2	1.26	V
		$V_{CCO}$	1.7	1.8	1.9	V
$I_{CC}$	Power Supply Current	Max. $V_{CC}$		42	55	mA
$I_{CCO}$	Power Supply Current	No Load. Max $V_{CCO}$		32	42	mA
$R_{IN}$	Input Resistance ( $IN$ -to- $V_T$ , $/IN$ -to- $V_T$ )		45	50	55	$\Omega$
$R_{DIFF\_IN}$	Differential Input Resistance ( $IN$ -to- $/IN$ )		90	100	110	$\Omega$
$V_{IH}$	Input HIGH Voltage ( $IN$ , $/IN$ )	$IN$ , $/IN$	1.2		$V_{CC}$	V
$V_{IL}$	Input LOW Voltage ( $IN$ , $/IN$ )	$V_{IL}$ with $V_{IH} = 1.2V$	0.2		$V_{IH}-0.1$	V
$V_{IH}$	Input HIGH Voltage ( $IN$ , $/IN$ )	$IN$ , $/IN$	1.14		$V_{CC}$	V
$V_{IL}$	Input LOW Voltage ( $IN$ , $/IN$ )	$V_{IL}$ with $V_{IH} = 1.14V$ , (1.2V-5%)	0.66		$V_{IH}-0.1$	V
$V_{IN}$	Input Voltage Swing ( $IN$ , $/IN$ )	see Figure 3a	0.1		1.0	V
$V_{DIFF\_IN}$	Differential Input Voltage Swing ( $ IN - /IN $ )	see Figure 3b	0.2		2.0	V
$V_{IN\_FSI}$	Input Voltage Threshold that Triggers FSI			30	100	mV
$V_{T\_IN}$	Voltage from Input to $V_T$				1.28	V

**Notes:**

1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.
2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
3. Package thermal resistance assumes exposed pad is soldered (or equivalent) to the device's most negative potential on the PCB.  $\psi_{JB}$  and  $\theta_{JA}$  values are determined for a 4-layer board in still-air number, unless otherwise stated.
4. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

## CML Outputs DC Electrical Characteristics<sup>(5)</sup>

$V_{CCO} = 1.14V$  to  $1.26V$   $R_L = 50\Omega$  to  $V_{CCO}$ ,

$V_{CCO} = 1.7V$  to  $1.9V$ ,  $R_L = 50\Omega$  to  $V_{CCO}$  or  $100\Omega$  across the outputs,

$V_{CC} = 2.375V$  to  $2.625V$ .  $T_A = -40^\circ C$  to  $+85^\circ C$ , unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
$V_{OH}$	Output HIGH Voltage	$R_L = 50\Omega$ to $V_{CCO}$	$V_{CCO} - 0.020$	$V_{CCO} - 0.010$	$V_{CCO}$	V
$V_{OUT}$	Output Voltage Swing	See Figure 3a	300	390	475	mV
$V_{DIFF\_OUT}$	Differential Output Voltage Swing	See Figure 3b	600	780	950	mV
$R_{OUT}$	Output Source Impedance		45	50	55	$\Omega$

## LVTTTL/CMOS DC Electrical Characteristics<sup>(5)</sup>

$V_{CC} = 2.5V \pm 5\%$ ;  $V_{CCO} = +1.14V$  to  $+1.26V$  or  $+1.7V$  to  $+1.9V$ ;  $T_A = -40^\circ C$  to  $+85^\circ C$ , unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
$V_{IH}$	Input HIGH Voltage		2.0		$V_{CC}$	V
$V_{IL}$	Input LOW Voltage				0.8	V
$I_{IH}$	Input HIGH Current		-125		30	$\mu A$
$I_{IL}$	Input LOW Current		-300			$\mu A$

**Note:**

5. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

## AC Electrical Characteristics

$V_{CCO} = 1.14V$  to  $1.26V$   $R_L = 50\Omega$  to  $V_{CCO}$ ,

$V_{CCO} = 1.7V$  to  $1.9V$ ,  $R_L = 50\Omega$  to  $V_{CCO}$  or  $100\Omega$  across the outputs,

$V_{CC} = 2.375V$  to  $2.625V$ .  $T_A = -40^\circ C$  to  $+85^\circ C$ , unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
$f_{MAX}$	Maximum Frequency	NRZ Data	3.2			Gbps
		$V_{OUT} > 200mV$ Clock	2.5			GHz
$t_{PD}$	Propagation Delay	IN-to-Q $V_{IN}: 100mV-200mV$ , Note 6, Figure 1a	250	350	500	ps
		SEL-to-Q $V_{IN}: >200mV$ , Note 6, Figure 1a	200	300	400	ps
		Figure 1a	90		350	ps
$t_{Skew}$	Input-to-Input Skew	Note 6		5	20	ps
	Output-to-Output skew	Note 7		3	15	ps
	Part-to-Part Skew	Note 8			75	ps
$t_{Jitter}$	Data Random Jitter	Note 9			1	ps <sub>RMS</sub>
	Deterministic Jitter	Note 10			10	ps <sub>PP</sub>
	Clock Cycle-to-Cycle Jitter	Note 11			1	ps <sub>RMS</sub>
	Total Jitter	Note 12			10	ps <sub>PP</sub>
	Crosstalk Induced Jitter (Adjacent Channel)	Note 13			0.7	ps <sub>PP</sub>
$t_R$ $t_F$	Output Rise/Fall Times (20% to 80%)	At full output swing.	30	60	95	ps
	Duty Cycle	Differential I/O	47		53	%

### Notes:

- Input-to-Input skew is the difference in time between both inputs, measured at the same output, for the same temperature, voltage and transition.
- Output-to-Output skew is the difference in time between both outputs, receiving data from the same input, for the same temperature, voltage and transition.
- Part-to-part skew is defined for two parts with identical power supply voltages at the same temperature and no skew at the edges at the respective inputs.  $V_{IN} > 200mV$  with input  $t_r/t_f \leq 300ps$  (20% to 80%).
- Random jitter is measured with a K28.7 pattern, measured at  $\leq f_{MAX}$ .
- Deterministic jitter is measured at 2.5Gbps with both K28.5 and  $2^{23}-1$  PRBS pattern.
- Cycle-to-cycle jitter definition: the variation period between adjacent cycles over a random sample of adjacent cycle pairs.  $t_{JITTER\_CC} = T_n - T_{n+1}$ , where T is the time between rising edges of the output signal.
- Total jitter definition: with an ideal clock input frequency of  $\leq f_{MAX}$  (device), no more than one output edge in  $10^{12}$  output edges will deviate by more than the specified peak-to-peak jitter value.
- Crosstalk induced jitter is defined as the added jitter that results from signals applied to the adjacent channel. It is measured at the output while applying a similar, differential clock frequency to both inputs that is asynchronous with respect to each other.

## Functional Description

### Fail-Safe Input (FSI)

The input includes a special failsafe circuit to sense the amplitude of the input signal and to latch the output when there is no input signal present, or when the amplitude of the input signal drops sufficiently below  $100\text{mV}_{\text{PK}}$  ( $200\text{mV}_{\text{PP}}$ ), typically  $30\text{mV}_{\text{PK}}$ . Maximum frequency of the SY54023R is limited by the FSI function.

### Input Clock Failure Case

If the input clock fails to a floating, static, or extremely low signal swing, the FSI function will eliminate a metastable condition and guarantee a stable output. No ringing and no undetermined state will occur at the output under these conditions.

Note that the FSI function will not prevent duty cycle distortion in case of a slowly deteriorating (but still toggling) input signal close to the FSI threshold. Due to the FSI function, the propagation delay will depend on rise and fall time of the input signal and on its amplitude. Refer to "Typical Characteristics" for detailed information

## Interface Applications

For Input Interface Applications, see Figures 4a through 4f and for CML Output Termination, see Figures 5a through 5d.

### CML Output Termination with VCCO 1.2V

For VCCO of 1.2V, Figure 5a, terminate the output with  $50\Omega$ -to-1.2V, DC-coupled, not  $100\Omega$  differentially across the outputs.

If AC-coupling is used, Figure 5d, terminate into  $50\Omega$ -to-1.2V before the coupling capacitor and then connect to a high value resistor to a reference voltage.

Do not AC couple with internally terminated receiver. For example,  $50\Omega$  ANY-IN input. AC-coupling will offset the output voltage by 200mV and this offset voltage will be too low for proper driver operation.

Any unused output pair needs to be terminated when VCCO is 1.2V, do not leave floating.

### CML Output Termination with VCCO 1.8V

For VCCO of 1.8V, Figure 5a and Figure b, terminate with either  $50\Omega$ -to-1.8V or  $100\Omega$  differentially across the outputs. AC- or DC-coupling is fine.

### Input AC Coupling

The SY54023R input can accept AC-coupling from any driver. Bypass VT with a  $0.1\mu\text{F}$  low ESR capacitor to VCC as shown in Figures 4c and 4d. VT has an internal high impedance resistor divider as shown in Figure 2a, to provide a bias voltage for AC-coupling.

### Timing Diagrams

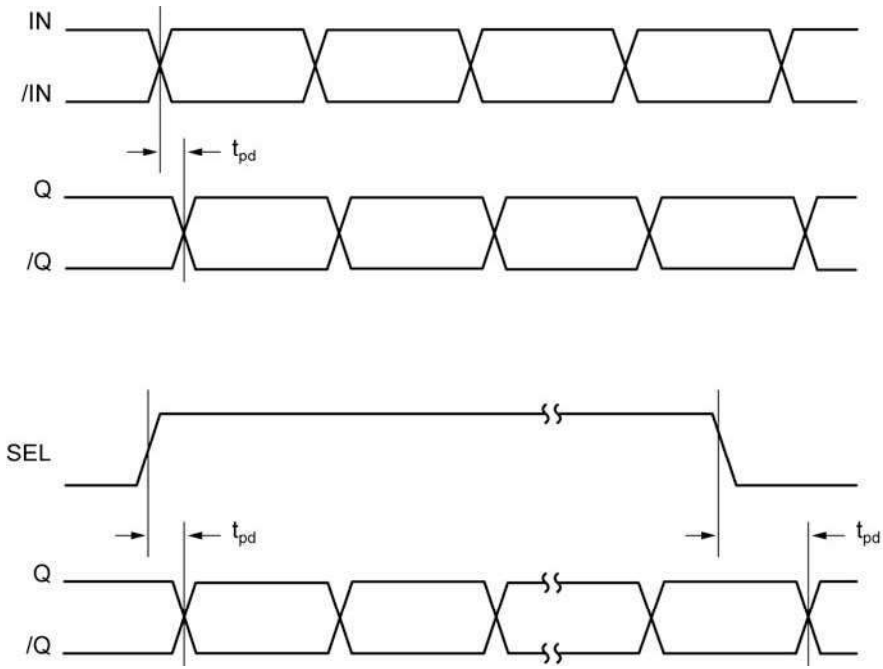


Figure 1a. Propagation Delay

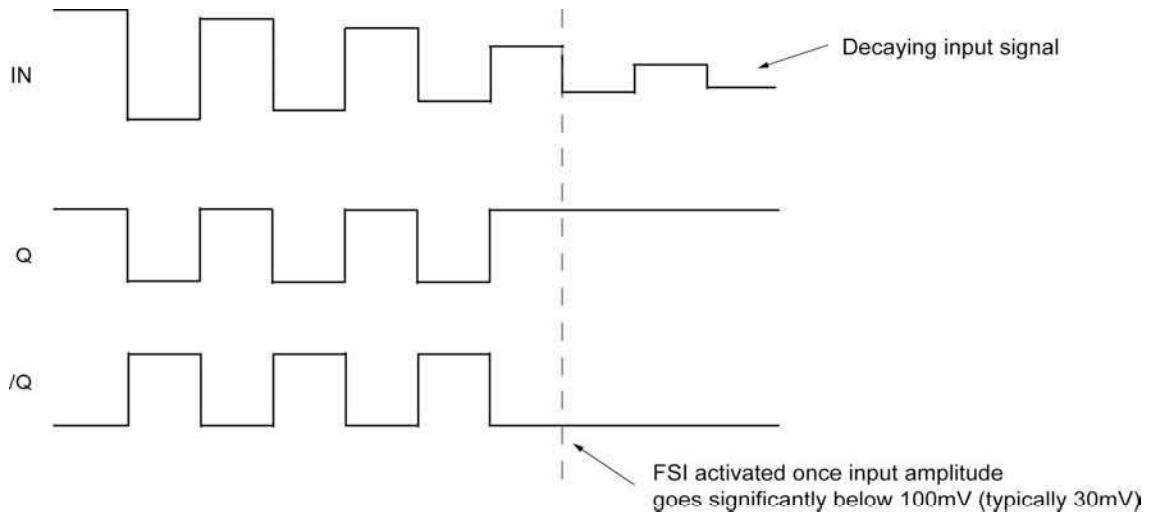
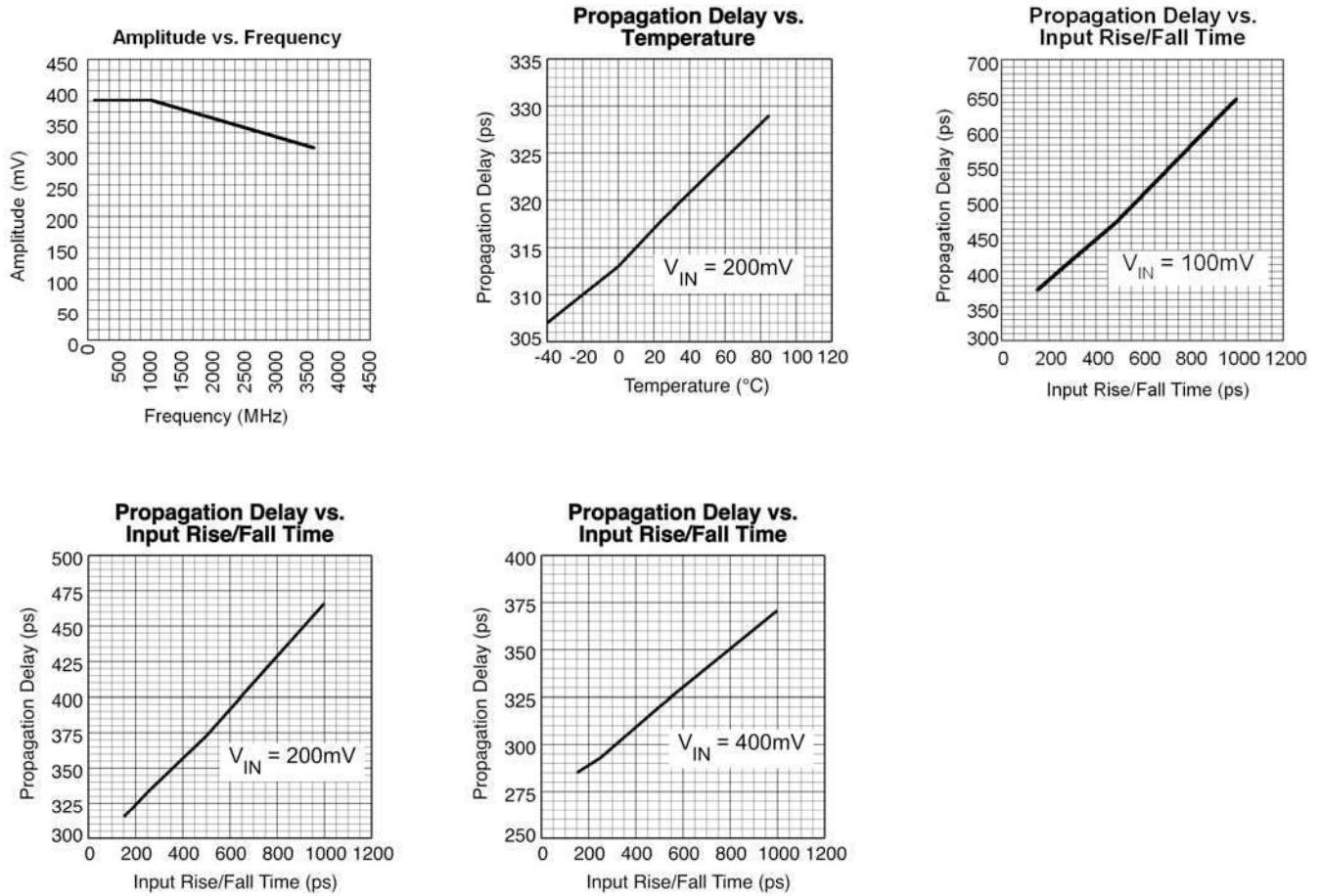


Figure 1b. Fail Safe Feature



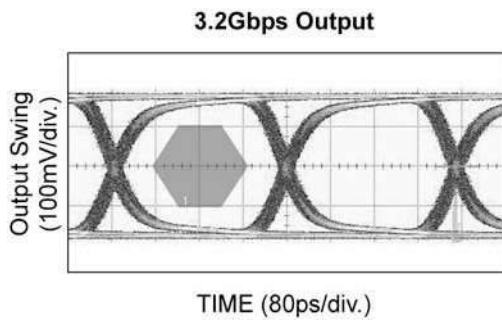
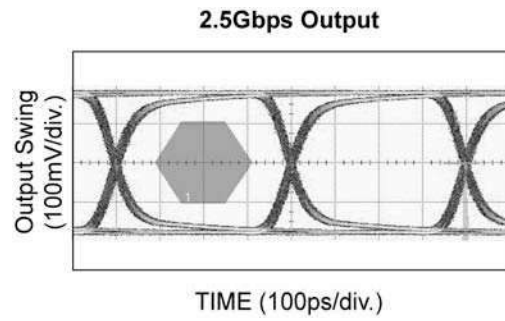
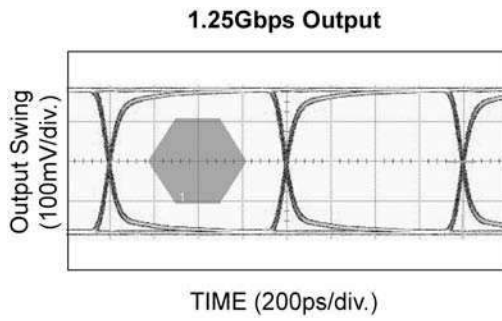
## Typical Characteristics

$V_{CC} = 2.5V$ ,  $V_{CCO} = 1.2V$ ,  $GND = 0V$ ,  $V_{IN} = 100mV$ ,  $R_L = 50\Omega$  to  $1.2V$ ,  $T_A = 25^\circ C$ , unless otherwise stated.



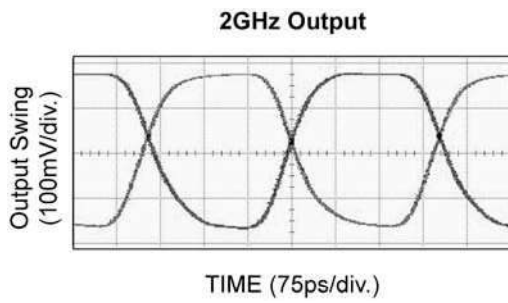
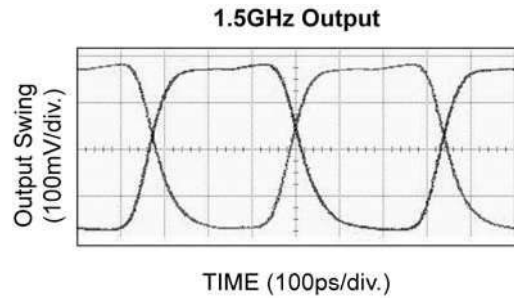
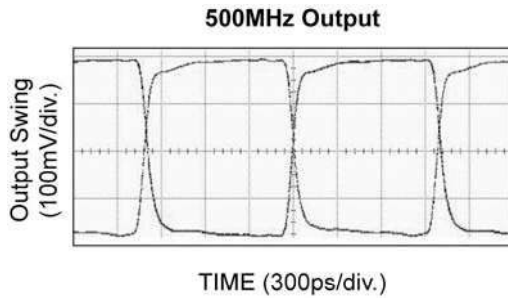
### Functional Characteristics

$V_{CC} = 2.5V$ ,  $V_{CCO} = 1.2V$ ,  $GND = 0V$ ,  $V_{IN} = 400mV$ ,  $R_L = 50\Omega$  to  $1.2V$ , Data Pattern:  $2^{23}-1$ ,  $T_A = 25^\circ C$ , unless otherwise stated.



### Functional Characteristics

$V_{CC} = 2.5V$ ,  $V_{CCO} = 1.2V$ ,  $GND = 0V$ ,  $V_{IN} = 400mV$ ,  $R_L = 50\Omega$  to  $1.2V$ ,  $T_A = 25^\circ C$ , unless otherwise stated.



## Input and Output Stage

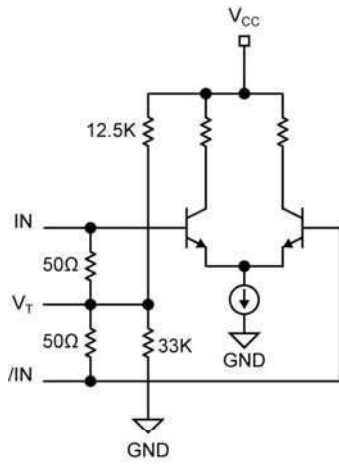


Figure 2a. Simplified Differential Input Buffer

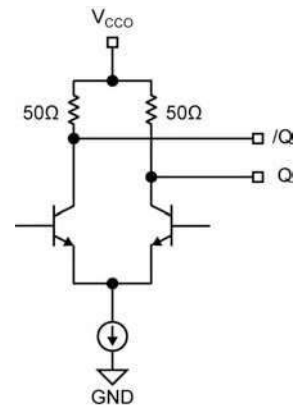


Figure 2b. Simplified CML Output Buffer

## Single-Ended and Differential Swings

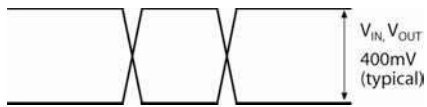


Figure 3a. Single-Ended Swing

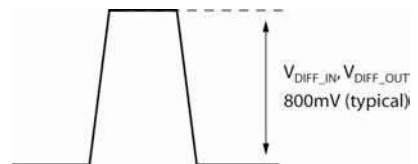
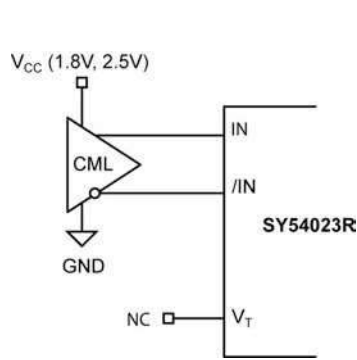
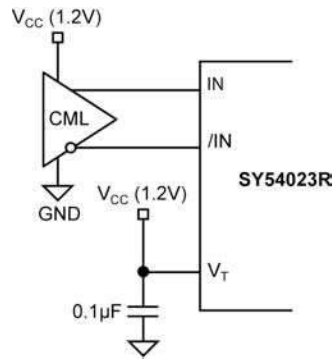


Figure 3b. Differential Swing

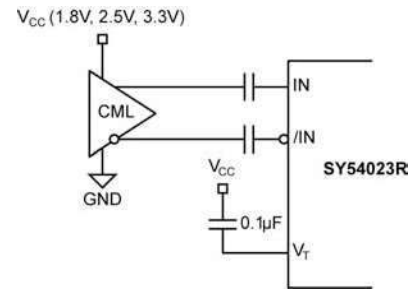
## Input Interface Applications



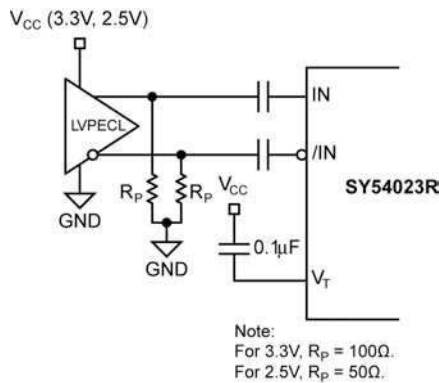
**Figure 4a. CML Interface (DC-Coupled, 1.8V, 2.5V)**



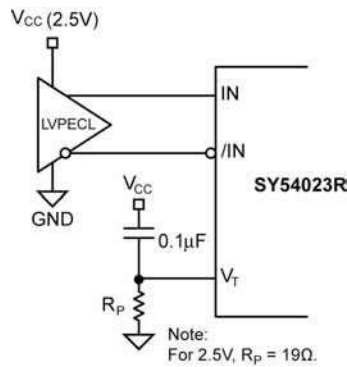
**Figure 4b. CML Interface (DC-Coupled, 1.2V)**



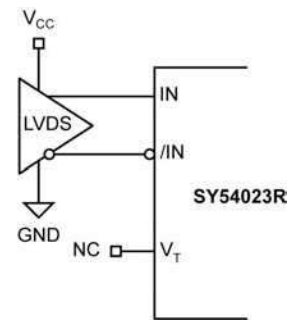
**Figure 4c. CML Interface (AC-Coupled)**



**Figure 4d. LVPECL Interface (AC-Coupled)**



**Figure 4e. LVPECL Interface (DC-Coupled)**



**Figure 4f. LVDS Interface**

### CML Output Termination

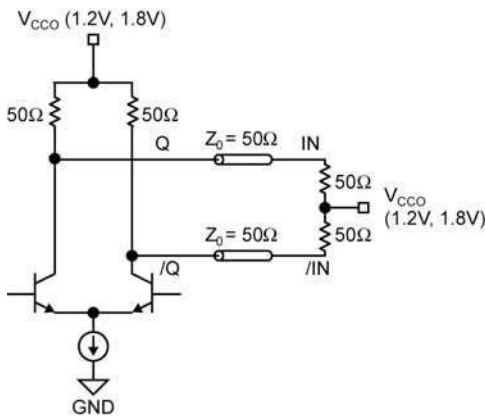


Figure 5a. 1.2V or 1.8V CML DC-Coupled Termination

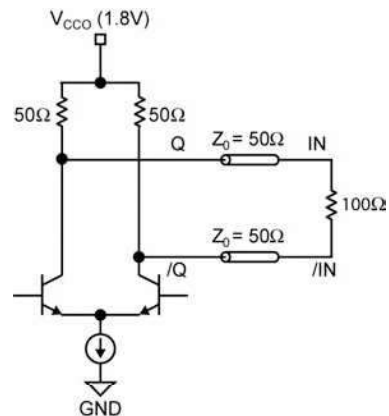


Figure 5b. 1.8V CML DC-Coupled Termination

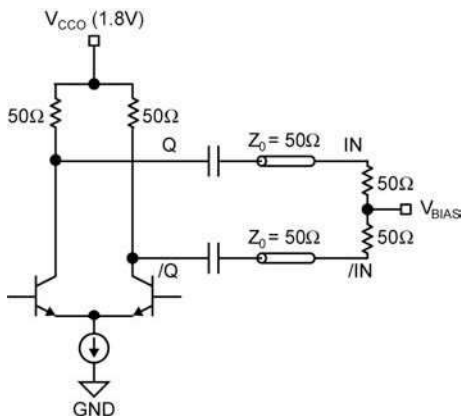


Figure 5c. CML AC-Coupled Termination  
(V<sub>CCO</sub> 1.8V only)

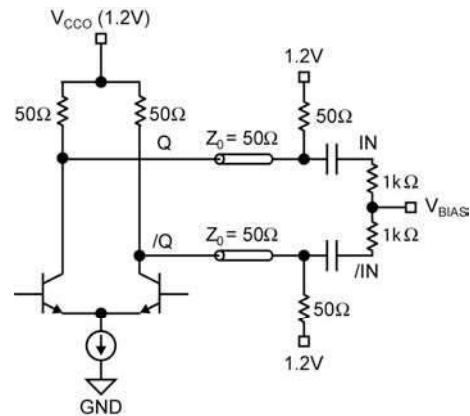
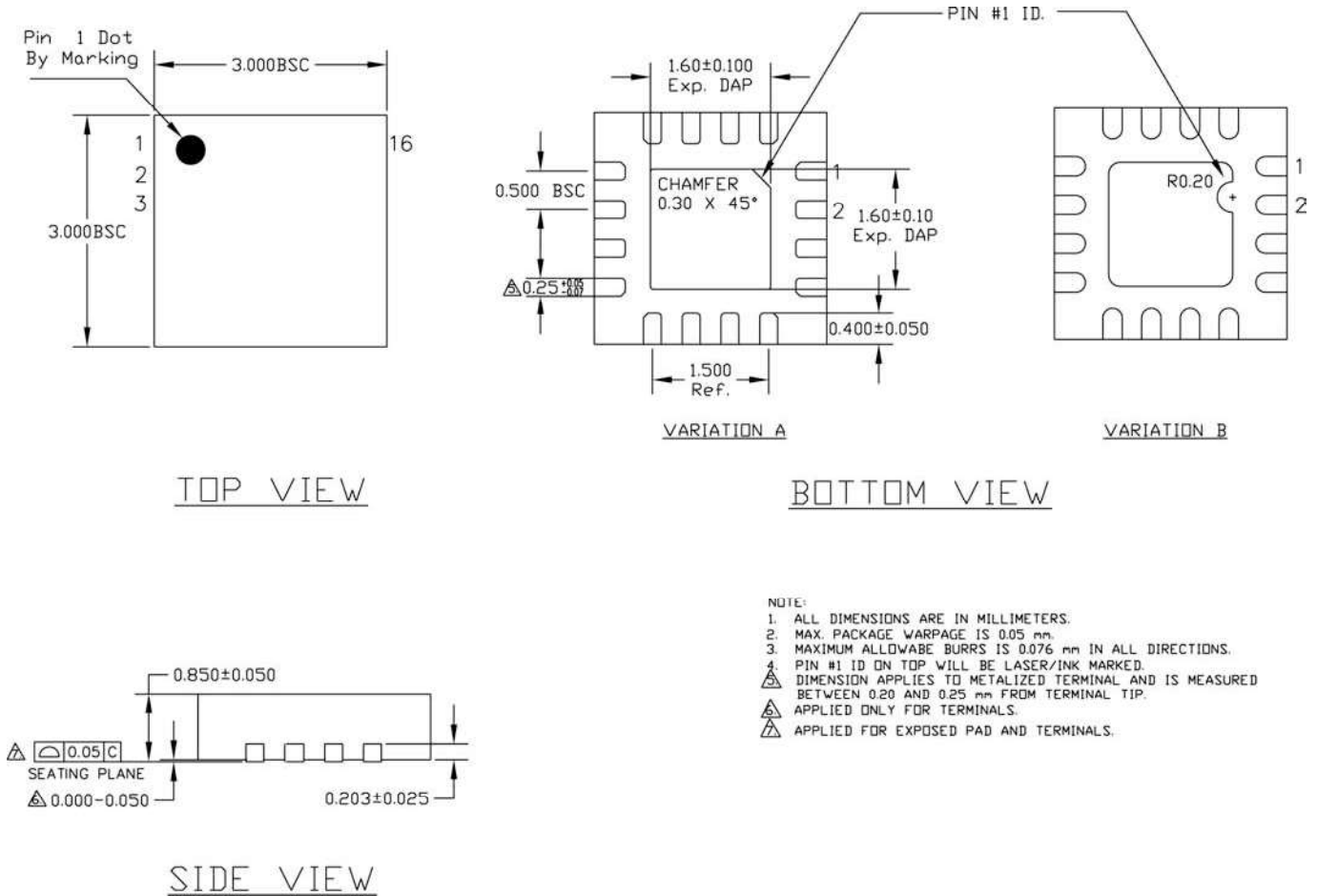


Figure 5d. CML AC-Coupled Termination  
(V<sub>CCO</sub> 1.2V only)

### Related Product and Support Documents

Part Number	Function	Datasheet Link
SY54023AR	3.2Gbps Precision, 2x2 Crosspoint Switch with Internal Termination	<a href="http://www.micrel.com/page.do?page=/product-info/products/sy54023ar.shtml">http://www.micrel.com/page.do?page=/product-info/products/sy54023ar.shtml</a>
HBW Solutions	New Products and Termination Application Notes	<a href="http://www.micrel.com/page.do?page=/product-info/as/HBWolutions.shtml">http://www.micrel.com/page.do?page=/product-info/as/HBWolutions.shtml</a>

**Package Information**



**16-Pin MLF<sup>®</sup> (3mm x3mm) (MLF-16)**

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